Hirata

Security code : 6258
August 2025

Financial Results Explanatory Materials

FY2025 (March 2026)
First quarter

Note : This document has been translated from the Japanese original for reference purposes only. In the event of any discrepancy between this translated document and the Japanese original, the original shall prevail.

Hirata

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※FY2025 represents the fiscal year ending March 31, 2026.

Company Profile

Company Name	HIRATA Corporation
Address	111 Hitotsugi, Ueki, Kita, Kumamoto, 861-0198 Japan
Representatives	Yuichiro Hirata, President
Date Established	December 29, 1951
Capital	2,633 million yen
Our business	Manufacture and sales of various manufacturing systems, industrial robots and logistic equipment
Stock Exchange Listings	Tokyo Stock Exchange, Prime Market (Symbol:6258)
Employees	Consolidated 2,394 Non-Consolidated 1,569 ※As of June 30, 2025
Plants and office	7 bases in Japan(4 bases in Kumamoto 1 each in Tochigi, Shiga, Tokyo)
Subsidiaries	3 subsidiaries in Japan(2 in Kumamoto, 1 in Tokyo) 9 overseas subsidiaries(America、Mexico、Singapore、Thailand、Malaysia、2 in China、Taiwan、Germany※)

※ We started liquidation procedures of a subsidiary in Germany on May 1, 2025.

Ⅰ. FY2025 First Quarter Results (Consolidated)

Financial Summary

- **Order received** — Order received increased compared to the same period last year, driven by a large project related to internal combustion engines in the automobile-related business and continued strong demand for generative AI in the semiconductor-related business.
- **Sales** — Sales increased compared to the same period last year, supported by prior expansions in production capacity and workforce, resulting in revenue growth in both the automobile- and semiconductor-related business.
- **Operating profit** — Operating profit increased compared to the same period last year, supported by higher sales and improved cost ratios in the automobile-related business and other automatic labor-saving equipment.

(Units in millions of Yen)

	FY2024 1Q	FY2025 1Q	YoY Change	
	Actual results	Actual results	Amount of +/−	Percentage of +/−
Orders Received	19,892	24,706	4,813	24.2%
Net Sales	20,368	22,128	1,760	8.6%
Backlog of Orders	64,928	59,010	▲5,918	▲9.1%
Operating Profit (Profit ratio)	1,214 (6.0%)	1,713 (7.7%)	499	41.1%
Ordinary Profit	1,279	1,638	359	28.1%
Profit attributable to owners of parent	722	1,166	444	61.5%

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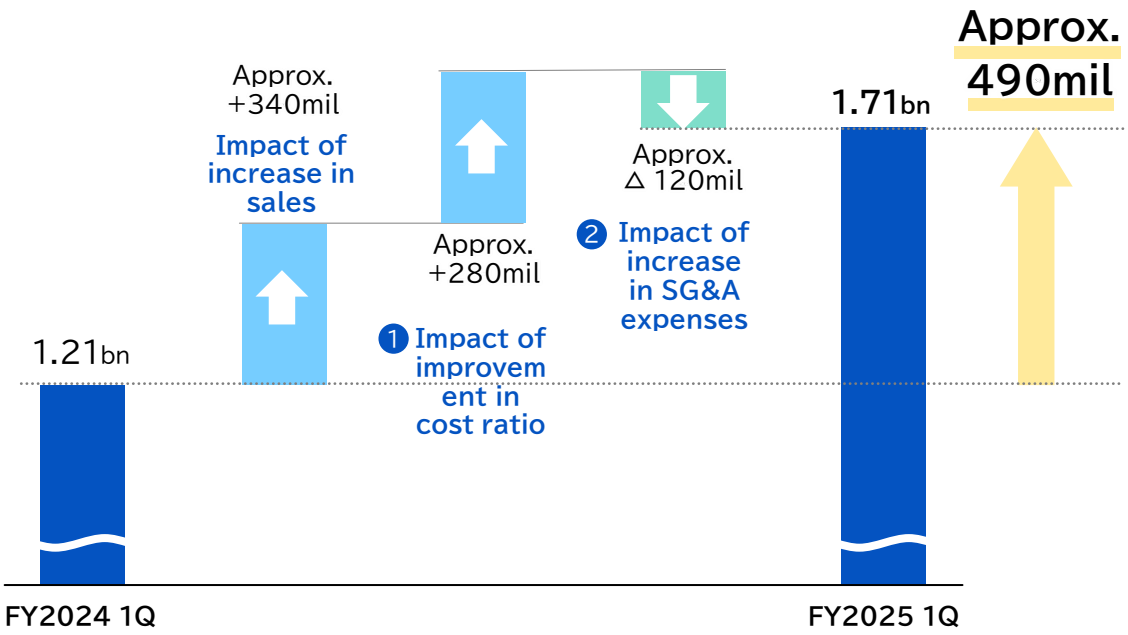
Factor Analysis on Changing Operating Profit

- **Operating profit increased approximately 490 million yen** from the same period of the previous year.
  - Main factors for increase：Increase in sales, Improvement in cost ratio
  - Main factors for decrease：Increase in the selling, general and administrative expenses



1 Impact of improvement in cost ratio

Cost ratio : 80.5% ⇒ 79.2%

Main factors contributing to the improvement in cost ratio

- Promotion of price pass-through (mainly in automobile-related business)
- Improved profitability through enhanced proficiency (mainly in automobile-related business)

2 Impact of increase in SG&A expenses

Main factors for the increase in SG&A expenses

- Increase in labor costs due to wage hikes and staff increases, etc.

Results by Segment

＊Elimination of intersegment transactions is included in 'Others'.

(Units in millions of Yen)		FY2024 1Q	FY2025 1Q	Amount of +/-	Percentage of +/-
Received orders	**Total**	**19,892**	**24,706**	**4,813**	**24.2%**
	Automobile	12,307	16,137	3,830	31.1%
	Semiconductor	4,828	6,436	1,608	33.3%
	Other Automatic Labor-saving Equipment	2,176	1,654	▲522	▲24.0%
	Others	580	477	▲102	▲17.7%
Net Sales	**Total**	**20,368**	**22,128**	**1,760**	**8.6%**
	Automobile	9,824	10,690	865	8.8%
	Semiconductor	7,055	7,959	904	12.8%
	Other Automatic Labor-saving Equipment	2,932	2,802	▲129	▲4.4%
	Others	556	675	119	21.5%
Backlog of orders	**Total**	**64,928**	**59,010**	**▲5,918**	**▲9.1%**
	Automobile	41,632	35,649	▲5,983	▲14.4%
	Semiconductor	17,243	17,490	247	1.4%
	Other Automatic Labor-saving Equipment	5,540	5,401	▲138	▲2.5%
	Others	512	468	▲43	▲8.6%
Operating profit	**Total**	**1,214**	**1,713**	**499**	**41.1%**
	Automobile	476	1,226	749	157.4%
	Semiconductor	920	291	▲629	▲68.4%
	Other Automatic Labor-saving Equipment	▲155	172	327	-
	Others	▲26	24	51	-

Results by Segment：Automobile-related business

- **Order received** Order received increased compared to the same period last year, driven by a large-scale project related to internal combustion engines (approximately 10 billion yen) and continued orders in the battery sector.
- **Sales** Sales increased compared to the same period last year, as production progressed mainly in internal combustion engine-related and battery-related projects.
- **Operating profit** Operating profit increased compared to the same period last year, as profitability significantly improved due to higher sales, active promotion of price pass-through in individual projects, and enhanced employee proficiency, in contrast to the previous year which saw higher development costs.

(Units in millions of Yen)

	FY2024 1Q		FY2025 1Q		YoY Change	
	Results	Segment composition	Results	Segment composition	Amount of +/-	Percentage of +/-
Received orders	**12,307**	-	**16,137**	-	3,830	31.1%
EV	8,828	71.7%	4,228	26.2%	▲4,600	▲52.1%
Others	3,478	28.3%	11,909	73.8%	8,430	242.3%
Net Sales	**9,824**	-	**10,690**	-	865	8.8%
EV	7,192	73.2%	7,309	68.4%	116	1.6%
Others	2,632	26.8%	3,381	31.6%	749	28.5%
Backlog of orders	**41,632**	-	**35,649**	-	▲5,983	▲14.4%
Operating profit	**476**	-	**1,226**	-	749	157.4%
Operating profit ratio	**4.8%**	-	**11.5%**	-	-	-

Results by Segment : Semiconductor-related business

- **Order received** Order received increased compared to the same period last year, supported by continued strong demand for generative AI-related products, maintaining a high level.
- **Sales** Sales increased compared to the same period last year, as production progressed mainly in wafer transfer systems in response to the rise in orders.
- **Operating profit** Operating profit decreased compared to the same period last year, primarily due to a worsening cost ratio resulting from rising material costs and delays in price pass-through.

(Units in millions of Yen)

	FY2024 1Q		FY2025 1Q		YoY Change	
	Results	Segment composition	Results	Segment composition	Amount of +/-	Percentage of +/-
Received orders	**4,828**	-	**6,436**	-	1,608	33.3%
Wafer transfer	4,269	88.4%	4,818	74.9%	549	12.9%
Others	558	11.6%	1,617	25.1%	1,058	189.5%
Net Sales	**7,055**	-	**7,959**	-	904	12.8%
Wafer transfer	4,970	70.5%	5,419	68.1%	449	9.0%
Others	2,084	29.5%	2,539	31.9%	455	21.8%
Backlog of orders	**17,243**	-	**17,490**	-	247	1.4%
Operating profit	**920**	-	**291**	-	▲629	▲68.4%
Operating profit ratio	**13.0%**	-	**3.7%**	-	-	-

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Results by Segment : Other Automatic Labor-saving Equipment

- **Order received** Order received decreased compared to the same period last year due to a decline in orders related to organic EL products, falling below the previous year's level.
- **Sales** Sales remained on par with the same period last year, as production progressed on organic EL-related orders received in the previous year.
- **Operating profit** Operating profit increased compared to the same period last year, supported by higher sales of organic EL-related business with high proficiency, along with the completion of previously unprofitable projects.

(Units in millions of Yen)

	FY2024 1Q		FY2025 1Q		YoY Change	
	Results	Segment composition	Results	Segment composition	Amount of +/-	Percentage of +/-
Received orders	2,176	-	1,654	-	▲522	▲24.0%
Net Sales	2,932	-	2,802	-	▲129	▲4.4%
Backlog of orders	5,540	-	5,401	-	▲138	▲2.5%
Operating profit	▲155	-	172	-	327	-
Operating profit ratio	▲5.3%	-	6.1%	-	-	-

Balance Sheet

Assets	FY2024	FY2025 1Q	YoY change
Current Assets	88,035	88,927	892
Cash & deposits	12,882	10,648	▲2,234
Accounts receivables	56,561	58,363	1,801
Inventories	15,510	16,929	1,419
Others	3,080	2,985	▲94
Non-Current Assets	42,243	42,432	189
Tangible fixed assets	26,592	26,491	▲101
Intangible fixed assets	1,160	1,179	18
Investment & other assets	14,489	14,762	272
Total Assets	130,278	131,360	1,081

Liabilities	FY2024	FY2025 1Q	YoY change
Current liabilities	43,295	42,651	▲643
Trade payables	10,574	10,285	▲289
Short-term borrowings※	22,330	22,715	385
Others	10,390	9,651	▲738
Fixed liabilities	18,143	20,578	2,434
Long-term borrowings	11,836	14,053	2,216
Others	6,307	6,525	218
Total Liabilities	61,439	63,230	1,791
Total Net Assets	68,839	68,129	▲709
Total Liabilities and Net Assets	130,278	131,360	1,081

(Units in millions of Yen)

Main factors for increase/decrease

- Cash and deposits decreased due to payments for bonuses and corporate taxes.
- Accounts receivables increased as production progresses, leading to a rise in trade receivables.
- Long-term borrowings increased as a result of large-scale projects and a growing number of long lead-time orders.

※ including long-term borrowings due withing one year

Ⅱ. FY2025 Full Year Forecasts (Consolidated)

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Full Year Forecast

- We anticipate an increase in revenue to 96 billion yen and an increase in operating profit to 8.4 billion yen for the fiscal year 2025 (ending March 2026).

There is no change to the earnings forecasts for the fiscal year ending March 31, 2026, disclosed on May 9, 2025.

(Units in millions of Yen)

	FY2024	FY2025	YoY Change	
	Results	Full year forecast	Amount of +/-	Percentage of +/-
Net Sales	88,483	96,000	7,516	8.5%
Automobile-related business	43,059	43,000	▲59	▲0.1%
Semiconductor-related business	30,186	36,000	5,813	19.3%
Other Automatic Labor-saving Equipment	13,096	15,000	1,903	14.5%
Others	2,141	2,000	▲141	▲6.6%
Operating Profit (x)	6,898 (7.8%)	8,400 (8.8%)	1,501	21.8%
Ordinary Profit (x)	6,889 (7.8%)	8,200 (8.5%)	1,310	19.0%
Profit attributable to owners of parent (x)	4,778 (5.4%)	5,700 (5.9%)	921	19.3%

Highlights of Full Year Forecast – Net Sales

- For the fiscal year 2025, we forecast sales revenue to be 96 billion yen, an increase of 8.5% compared to the previous period (the highest ever).
- We expect increased sales primarily in the semiconductor-related business.

There is no change to the earnings forecasts for the fiscal year ending March 31, 2026, disclosed on May 9, 2025.

① Automobile-related business 43 billion yen (almost the same compared to the previous year)

- We anticipate continued solid demand, primarily for ICE and EV batteries.
- As a core business for Hirata, we aim to improve productivity and ensure appropriate price pass-through.

② Semiconductor-related business 36 billion yen (+5.8 billion yen compared to the previous year)

- We expect semiconductor demand related to generative AI to remain strong in fiscal year 2025.
- By developing new products and enhancing supply capacity, we will respond to market needs and aim to increase our market share.

③ Other Automatic Labor-saving Equipment 15 billion yen (+1.9 billion yen compared to the previous year)

- Leveraging our past experiences, we will focus on responding to high-profit inquiries.

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Transition and Forecast of Dividends and Dividend Ratio per Share

(Units in Yen)

	FY2020	FY2021	FY2022	FY2023	FY2024	FY2025 forecast
Dividends per Share※	21.7	21.7	30.0	33.3	40.0	65.0
Consolidated dividend payout ratio(%)	16.6	25.2	21.9	23.9	25.9	35.3

Amount of treasure shares acquired :approx. 1 billion yen
Total shareholder return ratio : 46.7%

<Our approach to dividends>

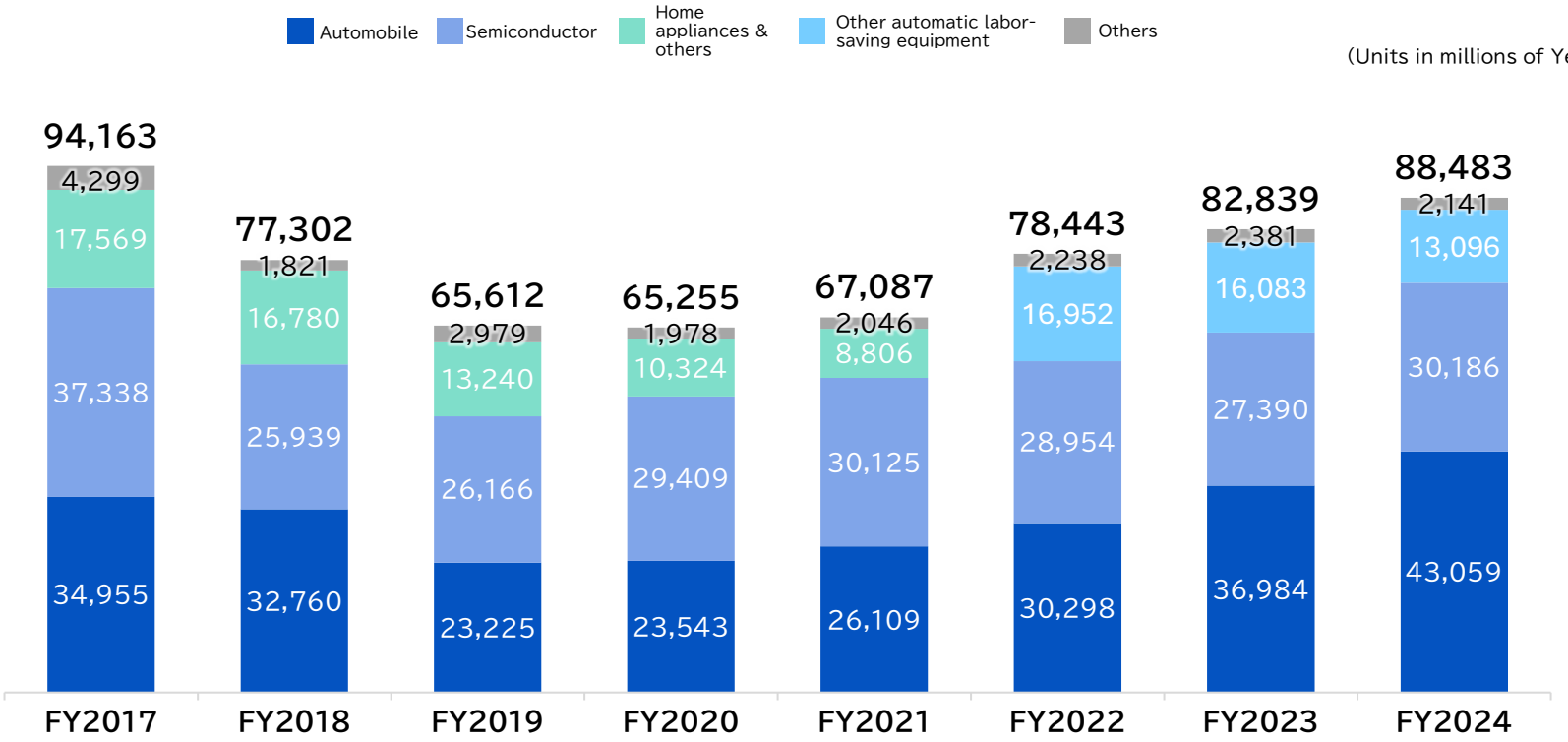
For dividends from the fiscal year 2025 onwards, based on the growth strategy aimed at enhancing corporate value as outlined in the medium-term management plan (FY2025-2027), we have established the allocation of growth investments and shareholder returns within our cash allocation policy, and decided to raise the target consolidated dividend payout ratio to a level from 20% to 35%.

For the fiscal year 2025's dividend, we anticipate a year-end dividend of 65 yen.

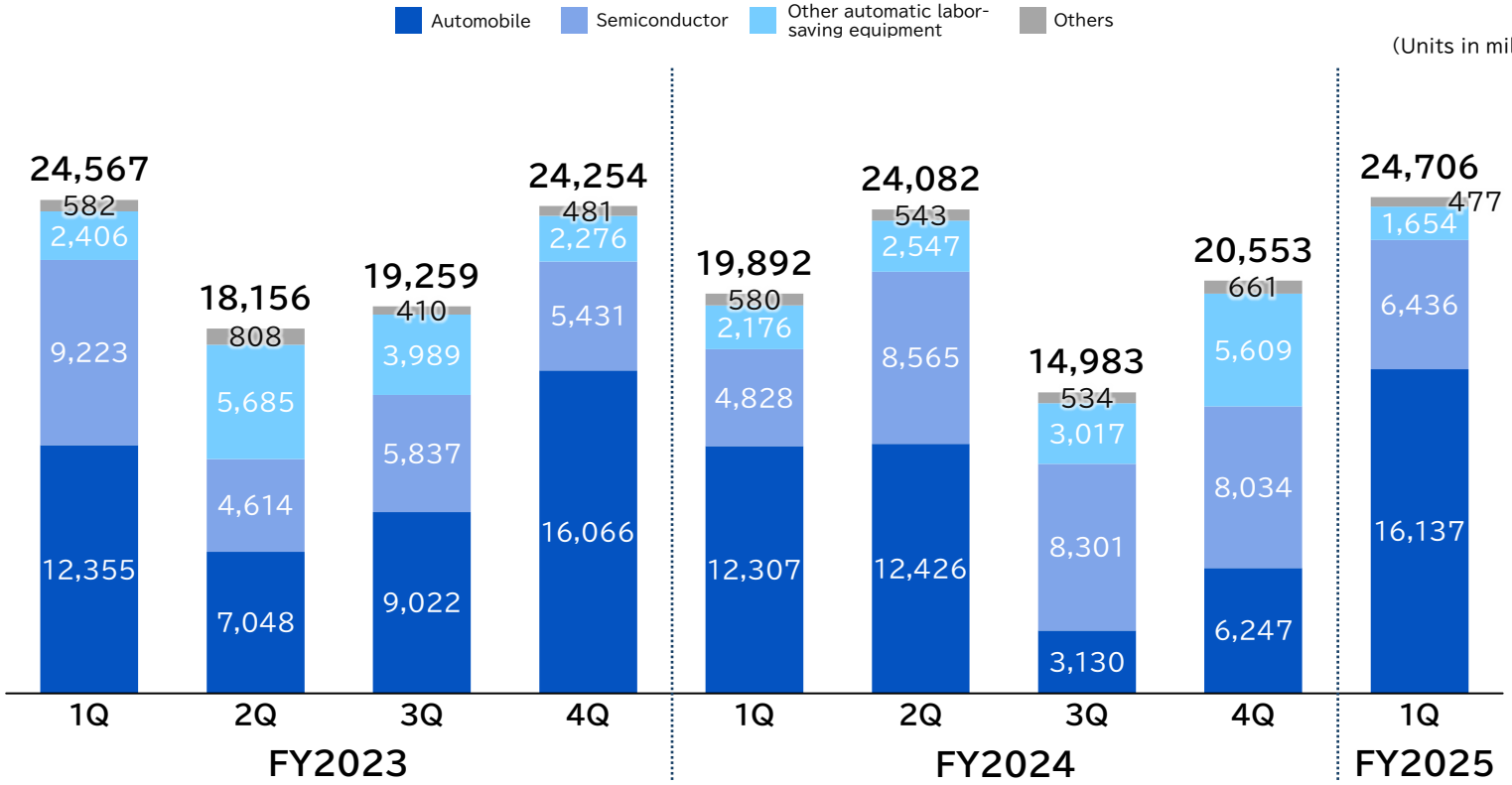
※The dividends per share reflects the impact of the share split (three-for-one), which became effective on April 1, 2025.

Ⅲ. Reference Data

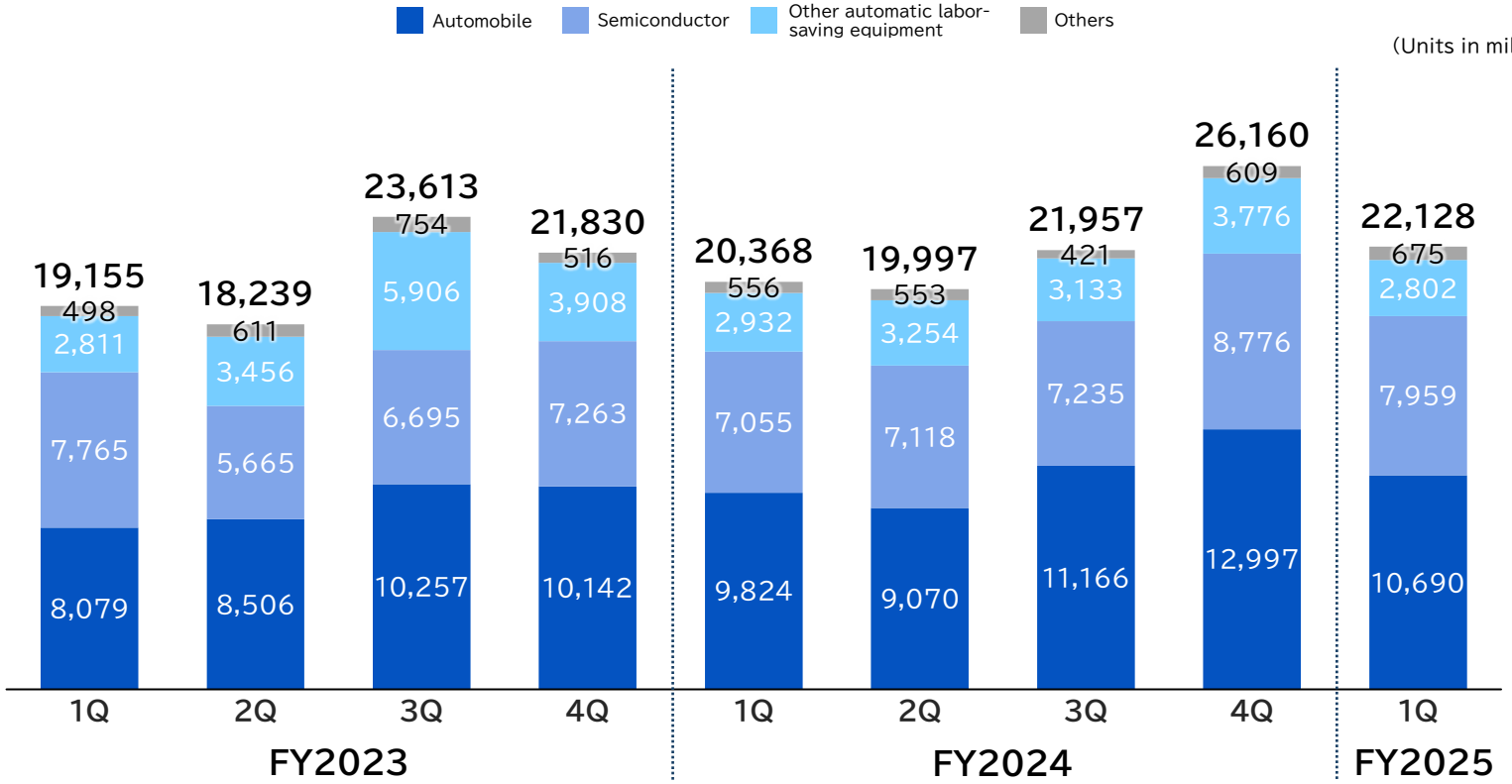
Net Sales by Business Segment (FY2017 to FY 2024)



Received Orders by Business Segment (Quarterly Trends)

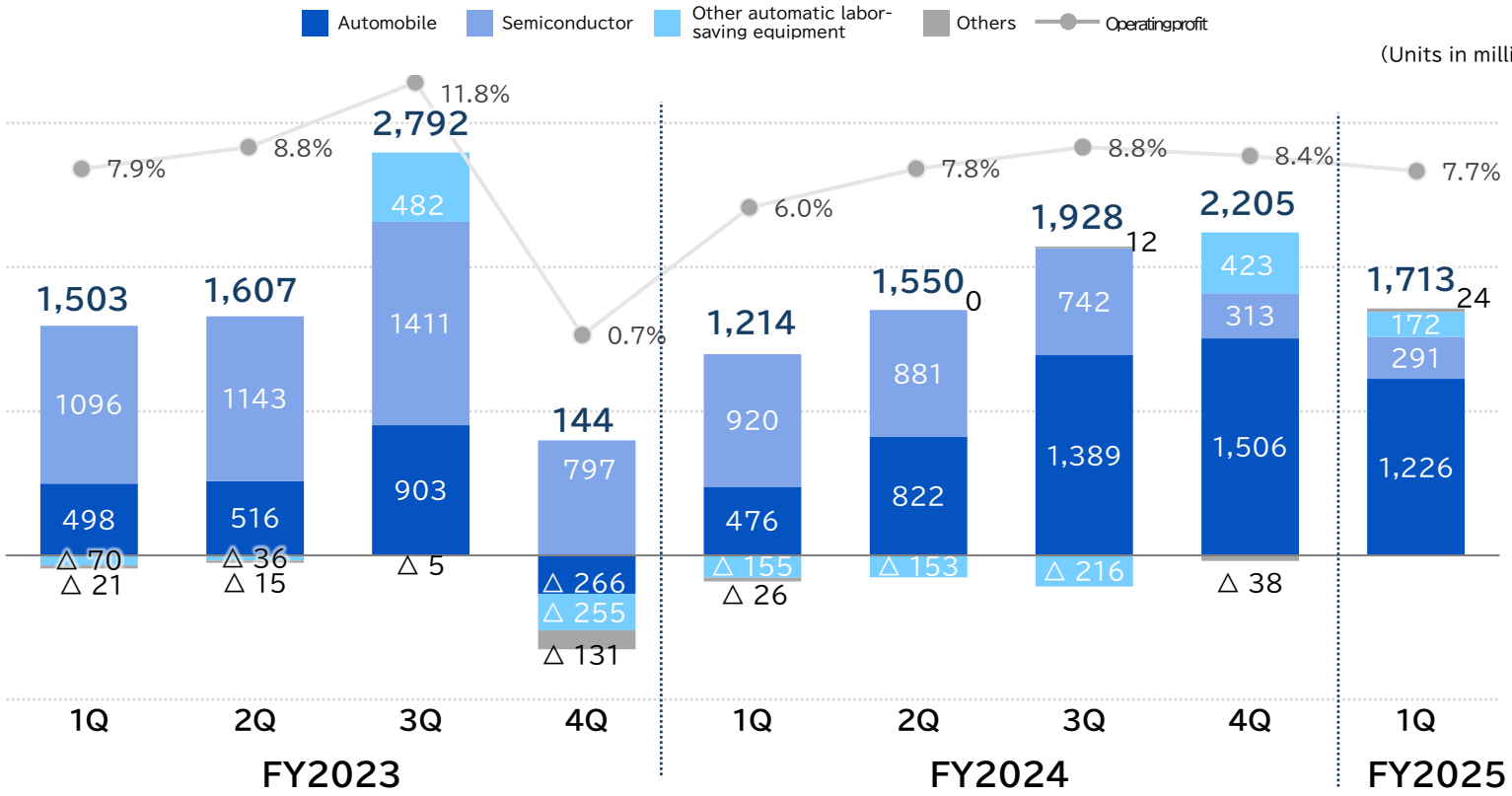


Net Sales by Business Segment (Quarterly Trends)

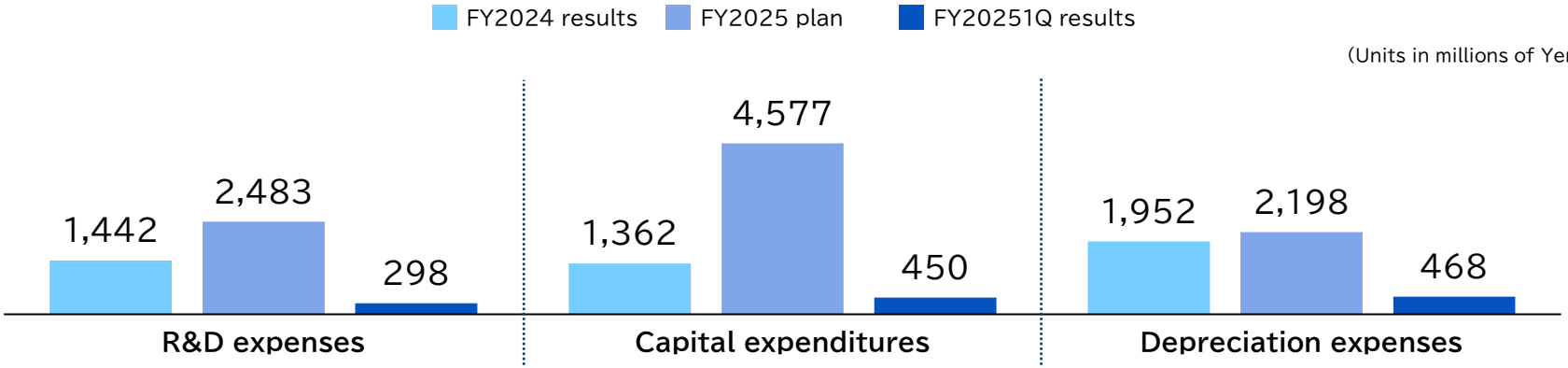


Operating Profit by Business Segment (Quarterly Trends)

*Others includes elimination



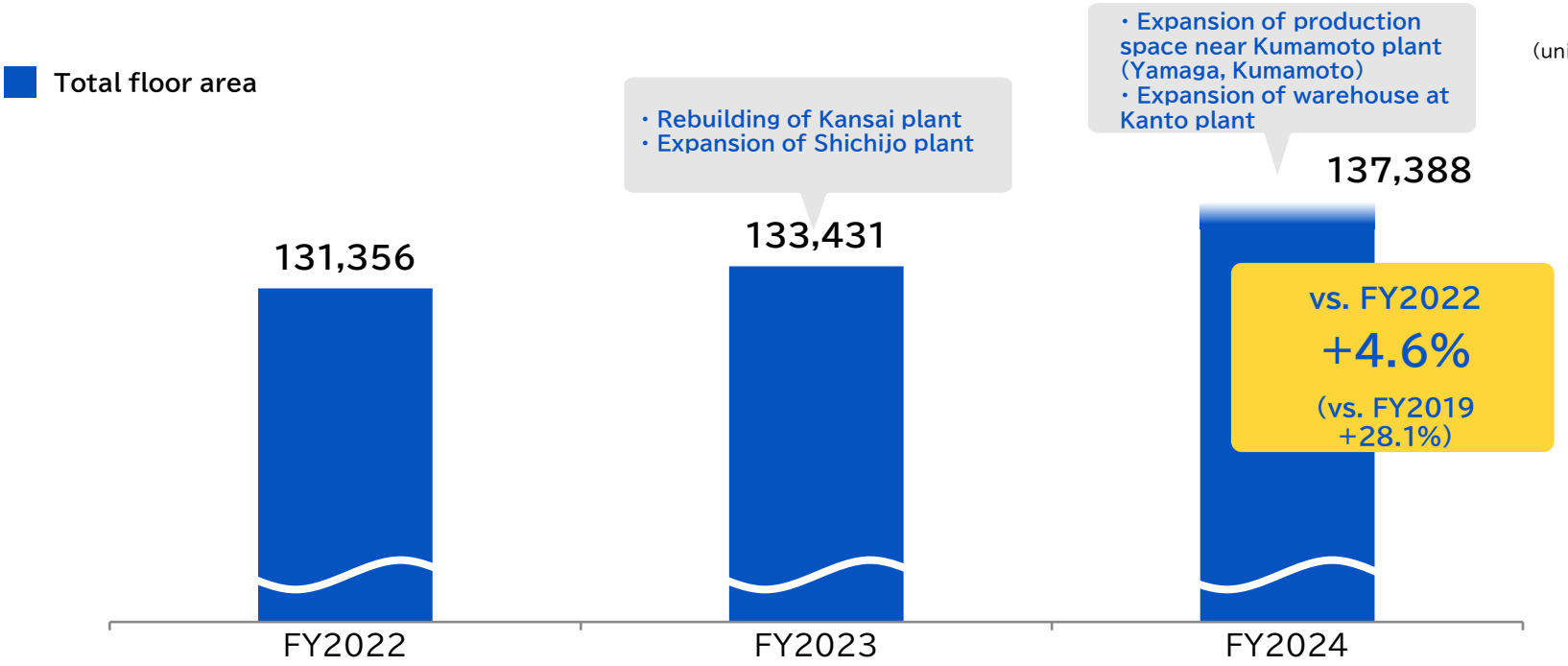
R&D expenses, CAPEX, and Depreciation expenses



	FY2024 results	FY2025 plan	Reasons of increase/decrease
R&D expenses	1,442 million yen	2,483 million yen	• Promote the development of mass-produced products
Capital expenditures	1,362 million yen	4,577 million yen	• Enhance production and development capabilities

Production space (Non-consolidated・End of period)

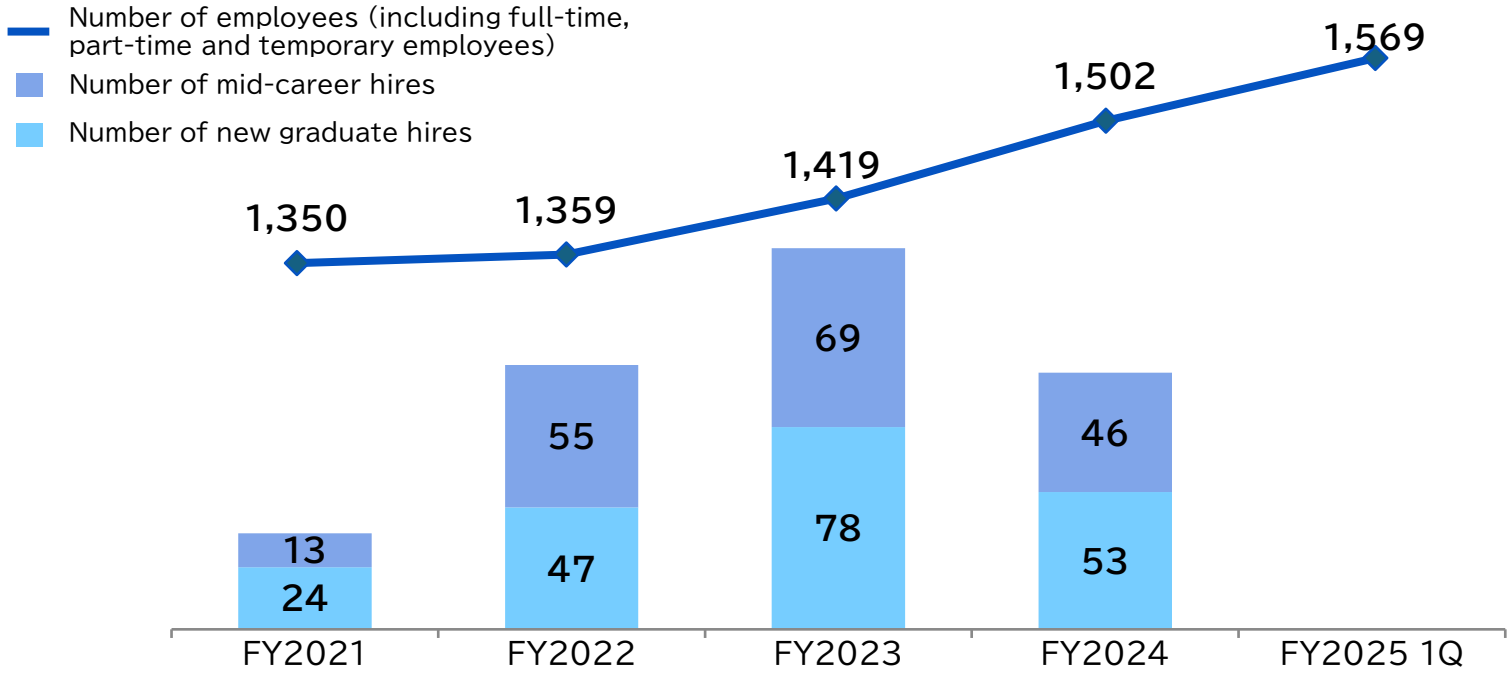
- We are actively working on the continuous expansion of production space to increase our production capacity.
- We secure production space in Yamaga City, which is adjacent to Kumamoto City, for the fiscal year 2024 as well.



Number of recruits・employees (Non-consolidated ・End of period)

- In anticipation of business expansion, we are committed to ensuring a continuous supply of talented professionals.
- We are working on talent retention through various measures such as wage improvements, workstyle reforms, enhancing employee benefits, and providing quality education and training opportunities.

(units in person)



External Environment and growth opportunities

Changes in the environment surrounding Hirata	Implications for our business
Serious deepening of labor shortages Surge in labor costs	Expansion of automation and labor-saving needs
Innovations in digital technologies centered around AI	Shift towards building equipment based on digitalization in production sites
Partial slowdown in the growth of the EV market Automakers' all-around strategies	Response to advanced automation needs across a wide range of automobile-related equipment
Expansion of the semiconductor market and rapid technological evolution	Development of high value-added products in response to changing customer needs
Growing importance of sustainability	Product development and business cultivation that meet needs such as reducing environmental impact
Demands for enhancing corporate value from the market	Early realization of a high-profit structure through the pursuit of earning power

Hirata's strengths

- Long-term relationships with global top companies
- Expertise, technologies, and resources developed as a manufacturer of production equipment
- Ability to continuously meet customer needs for over 70 years
- A trusted position in an industry with high barriers to entry

Role recognition

We recognize that expectations for our automation and labor-saving solutions from customers will continue to grow.

Topic：Receipt of large project orders

The list of large-scale purchase order projects we disclosed started from FY2023 and onwards

Business segment	Disclosure date		Outline of the equipment	Amount
Automobile -related business	2023	June	EDU assembly equipment for EVs	More than 8 billion yen
	2024	January	Battery charging and discharging related equipment for EVs	More than 4 billion yen
		February	Engine assembly equipment for internal combustion engines	Approximately 13 billion yen
		May	Battery charging and discharging related equipment for EVs	Approximately 2.5 billion yen
		August	Battery charging and discharging related equipment for EVs	Approximately 5.6 billion yen
		August	EDU assembly equipment for EVs	Approximately 8.7 billion yen
	2025	May	Engine assembly equipment for internal combustion engines	Approximately 10 billion yen

- We have been continuously receiving large-scale projects due to our ability to handle such projects and our proven track record of successful deliveries..

Strengthening our efforts in ESG management

2023	Apr.	The Sustainability Promotion Committee is established. Sustainability page is established in our web page and the dissemination of ESG information is been strengthened.
	Sep.	We sign the UN Global Compact.
	Oct.	Human rights due diligence is implemented.
	Nov.	We express our support for the Keidanren's "Charter of Corporate Behavior."
2024	Jan.	Code of Conduct of the Hirata Group is established. Human Rights Respect Working Group within the Sustainability Promotion Committee is established.
	Jun.	Selected as a constituent stock for: 「FTSE Blossom Japan Index」 「FTSE Blossom Japan Sector Relative Index」
	Nov.	We have endorsed the Keidanren Declaration for Biodiversity and Guideline.
2025	Mar.	We have obtained the "Silver" rating in the EcoVadis sustainability assessment.

WE SUPPORT UN GLOBAL COMPACT

FTSE Blossom Japan Index

FTSE Blossom Japan Sector Relative Index

SILVER | Top 15% ecovadis Sustainability Rating FEB 2025

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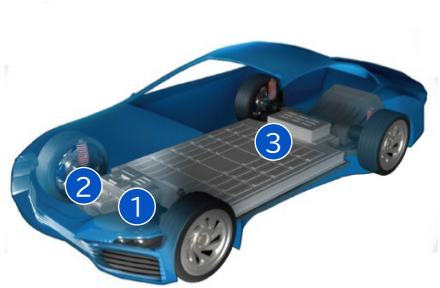
Business Overview：Main products of automobile-related business

- We continue to receive orders from North American automakers (Big three), North American emerging EV manufacturers, domestic electronic components manufacturers, focusing on EV related.

Main/Expansion Fields of EV-related business

Production equipment handled by Hirata



*Completed product image

1 EDU assembly equipment Main field

We manufacture EV-drive parts assembly equipment called EDU (Electric Drive Unit) combined with in-vehicle motors and gearboxes.

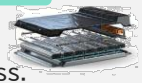

2 IGBT･Inverter assembly equipment Main field

We manufacture in-vehicle electronic components mounted on EVs and transmissions such as IGBT and inverters.


3 Battery-related assembly equipment Expansion field

(Cell charging / discharge process)

We manufacture conveying equipment for charging and discharging processes that are part of the battery cell progress.




Major markets, customers and competitive advantages

EDU assembly equipment

North America

Customers

・North American automakers (Big three)

・North American emerging EV manufacturers

IGBT･Inverter assembly equipment

Japan

Customers

Domestic electronic components manufacturers

Battery-related assembly equipment

(cell charging/discharging process)

Japan

Customers

Domestic battery manufacturers

Hirata's competitive advantages

- Technical capabilities to handle large facilities, some of which exceed 1 km in total length, solely in-house
- A vast factory that allows us to build the customer's production line in our factory and install it on site after verifying the production capacity and quality
- Integrated system from development to production and maintenance
- Engineering ability to respond to customer requests

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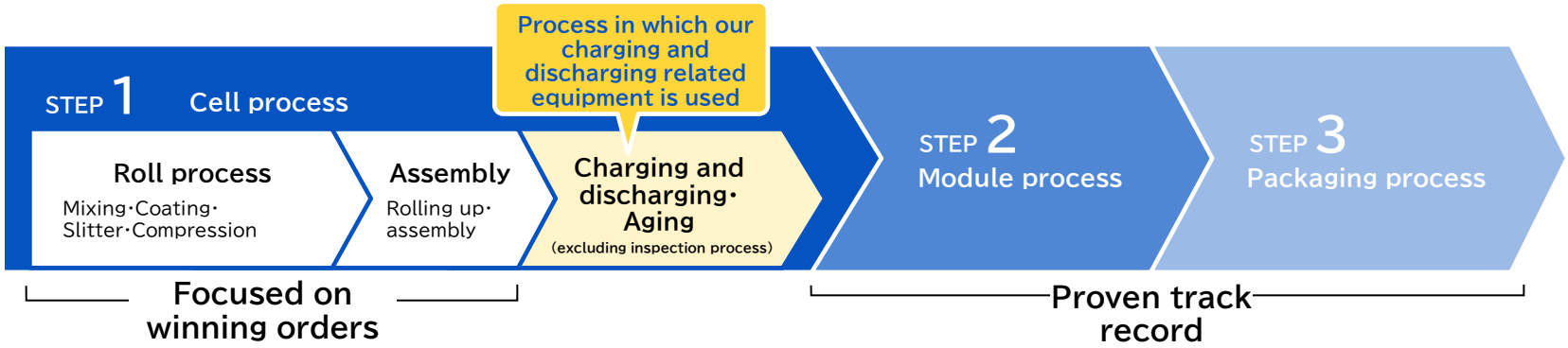
Business Overview：Charging and discharging related equipment

- This is equipment related to charge-discharge processes, which are responsible for the final stage of cell manufacturing: charging, discharging, and aging.
- We have a competitive advantage in systematization utilizing conveyance and stocking technologies.

Battery manufacturing process



Our products:
Charging and discharging related equipment

- The process of activating assembled cells (batteries) by repeatedly charging and discharging it to give it the functionality of a battery.
- We deliver the system to the customer by incorporating the charging and discharging machines procured from external suppliers into the transport lines and automated warehouses manufactured by us.
- The differentiating factor is our conveying and storage technology.

Transport system	This system provides optimal transfer between processes.
Warehouse system for aging	The system performs tests in high-temperature environments and measures the performance of cell voltages after a certain period of time in an automated warehouse.
Warehouse system for charging and discharging	It is used in a process in which a full charge and discharge are repeated several times. It takes several hours to set the charging capacity, charging speed, and number of repetitions.

Business Overview：Main products of semiconductor-related business

- We continue to receive orders mainly for wafer transport devices and handling devices between inspection devices for domestic device manufacturers.

Main/Expansion Fields of Semiconductor-related business

Main field

Wafer transport device


EFEM


Load port

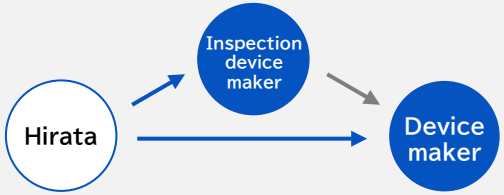

Transfer robot

We manufacture load port that incorporates silicon wafers into various treatment devices, wafer transport robot that can support the air and vacuum environment, and an integrated EFEM.

Main field

Transport device between inspection device

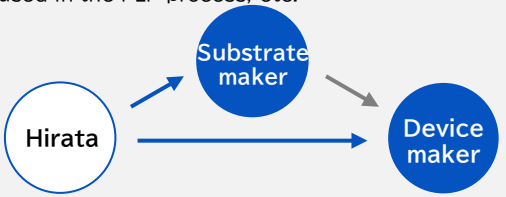
We manufacture handling equipment that transports the finished IC chips and inspection device to another tray.



Expansion field

PLP

We manufacture EFEM, load port, and wafer transfer robots for panel substrate transfer and transfer equipment for panel manufacturing used in the PLP process, etc.



Major markets, customers and competitive advantages

Wafer transport device

Japan

Customers

Domestic manufacturing equipment manufacturers

Transport device between inspection device

North America, Japan

Customers

- North American device makers
- Domestic inspection equipment manufacturers

PLP

North America, Europe, Japan

Customers

- North American device makers
- Domestic/European substrate manufacturers

Hirata's competitive advantages

- A wealth of component lineup
- Knowledge technology required for customization and optimization to meet customer requirements
- Integrated system from development to production and maintenance
- Engineering ability to respond to customer requests

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Business Overview ：Wafer transport device

- We design and manufacture load ports that take wafers into various processing equipment mainly used in the front-end process of semiconductor manufacturing, wafer transfer robots that transfer wafers, and EFEMs that integrate them.

Semiconductor manufacturing process

Process in which our wafter transfer devices are primarily used

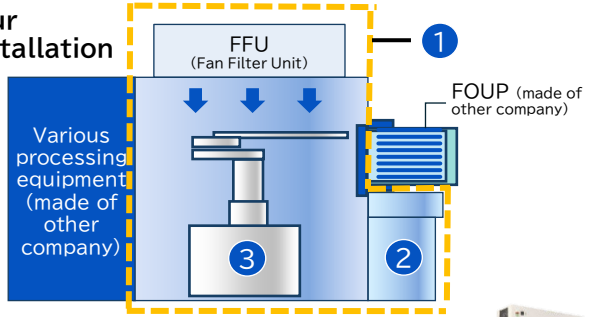
Design	Front-end process	Back-end process
• Design for circuit and pattern • Photomask creation	• Wafer fabrication • Making circuit pattern ·Oxidation of wafer surface ·Thin film formation ·Pattern transcription of photomask ·Ion implantation	• Dicing • Die bonding • Wire bonding • **Packaging** • Commercialization and final inspection

Image of our product installation

Multiple EFEM/load ports are used on a single line because multiple EFEM/load ports are installed at each processing unit.

Our main products

Image of our product installation



① EFEM (Equipment Front End Module)

It is placed for each processing unit, with a wafer transfer robot inside and a load port on the front.

② Load port

It opens and closes the lid on the back side of the FOUP ※, a device that makes up the EFEM, but is also sold as a stand-alone item.

③ Wafer transport robot

Wafers are removed from the FOUP and transferred to the processing equipment. After processing, the wafers are stocked back in the FOUP. It is a device that makes up the EFEM, but is also sold as a stand-alone item.

※**FOUP**：It is a container for wafers that holds multiple wafers and moves them between processes.

Business Overview：PLP

- We design and manufacture conveyance equipment used in PLP, an advanced packaging technology that is expected to expand.

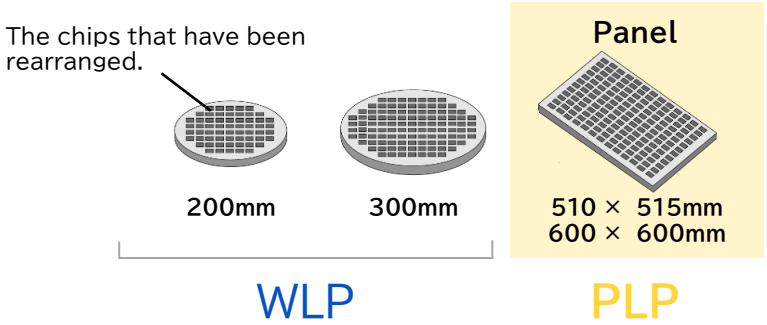
Semiconductor manufacturing process

Process in which our devices are primarily used

Design	Front-end process	Back-end process
• Design for circuit and pattern • Photomask creation	• Wafer fabrication • Making circuit pattern ·Oxidation of wafer surface ·Thin film formation ·Pattern transcription of photomask ·Ion implantation	• Dicing • Die bonding • Wire bonding • Packaging • Commercialization and final inspection

Difference of packaging process

Conventional packaging	Circuits are formed on wafters, and after cutting the chips into smaller pieces, they are individually bonded and encapsulated onto substrates to complete the product.
WLP (Wafer Level Package)	After cutting the chips individually, only the good chips are rearranged on the wafer, and then they are bonded and encapsulated onto the substrate while the chips are still on the wafer. They are then cut individually.
PLP (Panel Level Package)	After cutting the chips individually, only the good chips are rearranged on a square-shaped panel, and then they are bonded and encapsulated onto the substrate while the chips are still on the panel. They are then cut individually.



What is PLP (Panel Level Packaging) about?

- The packaging process involves rearranging numerous chips that have been individually cut after circuit formation onto thin, square-shaped substrates and then collectively molding them. This is a packaging technology called “PLP”.
- In PLP, panel substrates larger than the standard 300mm wafer size, such as 510x515mm square, are commonly used.
- The panel substrate uses printed circuit boards, glass substrates for LCD panel manufacturing, and copper plates.

Hirata

Business Overview：Other Automatic Labor-saving Equipment

- We manufacture products for various industrial fields such as organic EL vapor equipment, assembly equipment for home appliances, and medical･physics and chemical equipment.

Main/New Fields of Other Automatic Labor-saving Equipment

Main field

Medical physiology and chemical equipment

We manufacture a system for sample tests (pathological tissue specimen device and fully automatic continuous thinning device).

Main field

Assembly equipment for home appliances

We manufacture all equipment, including motor assembly equipment built into high-performance home appliances.

Organic EL Vapor Equipment

We are contracted to manufacture vacuum evaporation equipment for OLED panels.

New field for monetization

Focused ultrasound therapy equipment

- We are jointly developing a focused ultrasound treatment device targeting pancreatic cancer with SONIRE Therapeutics Inc (Headquartered in Shinjuku, Tokyo, hereinafter referred to as SONIRE).
- We aim for non-invasive cancer treatment that fuses SONIRE's Ultrasonic Technology with our robot technology.
- Clinical trials in humans have started, and we have begun development of the next generation of mass production equipment.

Major markets, customers and competitive advantages

Medical physiology and chemical equipment

Japan

Customers

Domestic medical specialty manufacturers

Assembly equipment for home appliances

Asia

Customers

Asian home appliance manufacturers

Organic EL Vapor equipment

Japan

Customers

Domestic manufacturing device manufacturers

Hirata's competitive advantages

- Extensive knowledge and expertise in production facilities and equipment in various fields
- Integrated system from development to production and maintenance
- Engineering ability to respond to customer requests

Hirata

Business Overview : High-Intensity Focused Ultrasound (HIFU) cancer treatment device

- We are applying our experience in specimen examination automation and robotics technology in the medical and scientific equipment field to enter the ”treatment” domain.

Hirata’s existing business
Biotechnology equipment department

Automation technology for specimen examination

Over 20 years of experience in medical devices
(Class I: General medical devices)

New partner
SONIRE Therapeutics Inc.
(SONIRE)

Clinical, clinical trial, and focused ultrasound technology

Technologies developed over more than 10 years in collaboration with Tokyo Women’s Medical University, Tohoku University, and Tokyo Medical University

Hirata’s existing technology
Robot division

Robot technology

Achievements in industrial robotics

Entering new fields of business

SONIRE conducts clinical trials, while Hirata establishes the manufacturing system.

Joint development of cancer treatment devices

Aim for sales launch and mass production
(Class Ⅲ:Highly managed medical devices)

- Hirata partners with SONIRE Therapeutics Inc. (SONIRE) in the medical and scientific equipment field.
- We conduct joint development of a cancer treatment device for clinical trials in humans (targeting inoperable pancreatic cancer)
- We develop device for minimally invasive treatment that does not involve skin incisions or organ removal.
- The devices are supplied to multiple domestic hospitals, and SONIRE are conducting domestic clinical trials. Hirata is providing after-sales service post-delivery.
- In the future, we aim to refine the device’s safety, usability, and design, and work towards the development of mass-produced devices and the establishment of a mass production system.
- We are planning to expand overseas, aiming for early delivery to overseas hospitals and after-sales service at our overseas locations.

Cautionary statement with this document

Please be aware that the performance forecasts and future predictions mentioned in this document are based on the information available to us at the time of its creation. They are subject to potential risks and uncertainties, such as changes in economic conditions, competition with other companies, and exchange rates. Therefore, please note that actual performance may significantly differ from the future outlook mentioned or described in this document due to various factors, including changes in the business environment.